January 2000

PRELIMINARY

FAIRCHILD SEMICONDUCTOR TM

FDS9926A

Dual N-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

These N-Channel 2.5V specified MOSFETs use Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 10V).

Applications

- Battery protection
- Load switch
- · Power management

Features

- 6.5 A, 20 V. $R_{DS(ON)} = 0.030 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 0.043 \ \Omega \ @ V_{GS} = 2.5 \ V.$
- · Optimized for use in battery protection circuits
- ±10 V_{GSS} allows for wide operating voltage range
- Low gate charge

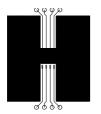


Absolute Maximum Ratings	T _A =25°C unless otherwise noted
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Symbol	Parameter		Ratings	Unit	
V _{DSS}	Drain-Source Voltage			20	V
V _{GSS}	Gate-Source Voltage			±10	V
ID	Drain Current – Con	tinuous	(Note 1a)	6.5	A
	– Puls	sed		20	
PD	Power Dissipation for	Dual Operation		2	W
	Power Dissipation for	Single Operation	(Note 1a)	1.6	
			(Note 1b)	1	
			(Note 1c)	0.9	
T _J , T _{STG}	Operating and Storage	e Junction Tempera	ature Range	-55 to +150	°C
Therma R _{eja}	Characteristic		t (Note 1a)	78	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)		(Note 1)	40	°C/W
	e Marking and			Tours with	0
Device I	-	vice F	Reel Size	Tape width	Quantity
	926A FDS	9926A	13"	12mm	2500 units

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	cal Characteristics	T _A = 25°C unless otherwise noted				
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS}=0~V,~I_D=250~\mu A$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -8 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.5	1	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, \qquad I_{D} = 6.5 \ A \\ V_{GS} = 2.5 \ V, \qquad I_{D} = 5.4 \ A \\ V_{GS} = 4.5 \ V, \ I_{D} = 6.5 \ A, \ T_{J} = 125^{\circ} C \end{array} $	5	0.025 0.036 0.035	0.030 0.043 0.050	Ω
I _{D(on)}	On–State Drain Current	$V_{GS} = 4.5 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	15			Α
g FS	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 3 A$	211	11		S
Dynamic	Characteristics	28 3 4				
C _{iss}	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		700		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		175		pF
Crss	Reverse Transfer Capacitance			85		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$		8	16	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		10	18	ns
t _{d(off)}	Turn–Off Delay Time			18	29	ns
t _f	Turn–Off Fall Time			5	10	ns
Q _g	Total Gate Charge	$V_{DS} = 10 V$, $I_{D} = 3A$,		7	10	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		1.2		nC
Q _{gd}	Gate-Drain Charge			1.9		nC
Drain-S	ource Diode Characteristic	s and Maximum Ratings				
Is	Maximum Continuous Drain-Source				1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 1.3 A$ (Note 2)		0.65	1.2	V







b) 125°/W when mounted on a 0.02 in² pad of 2 oz copper

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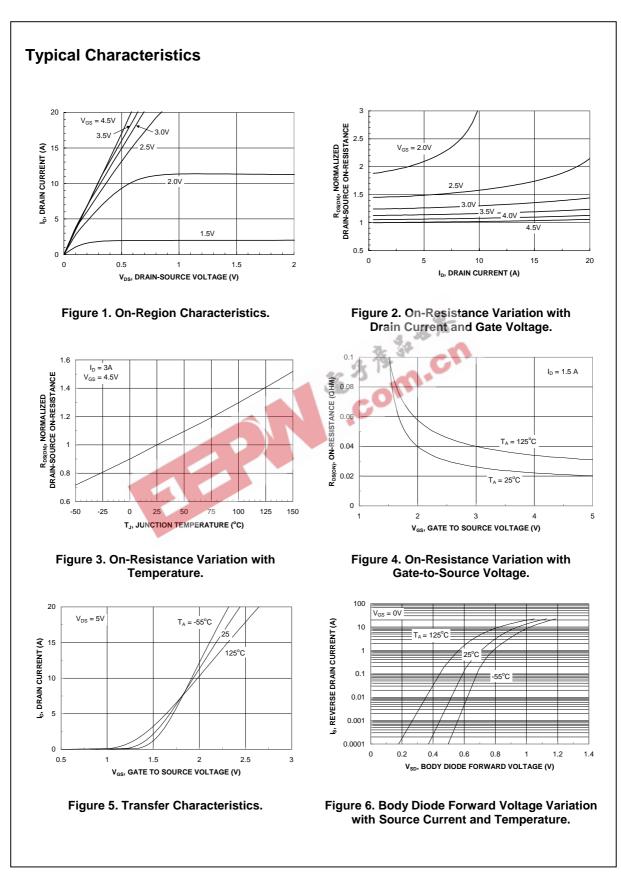
α ψ ψ ω c) 135°W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width <  $300\mu s,$  Duty Cycle < 2.0%

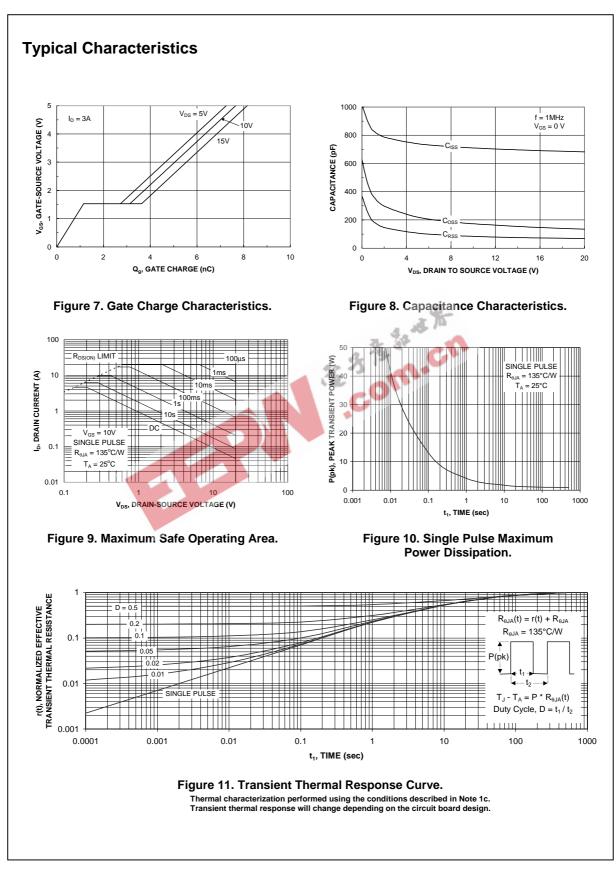
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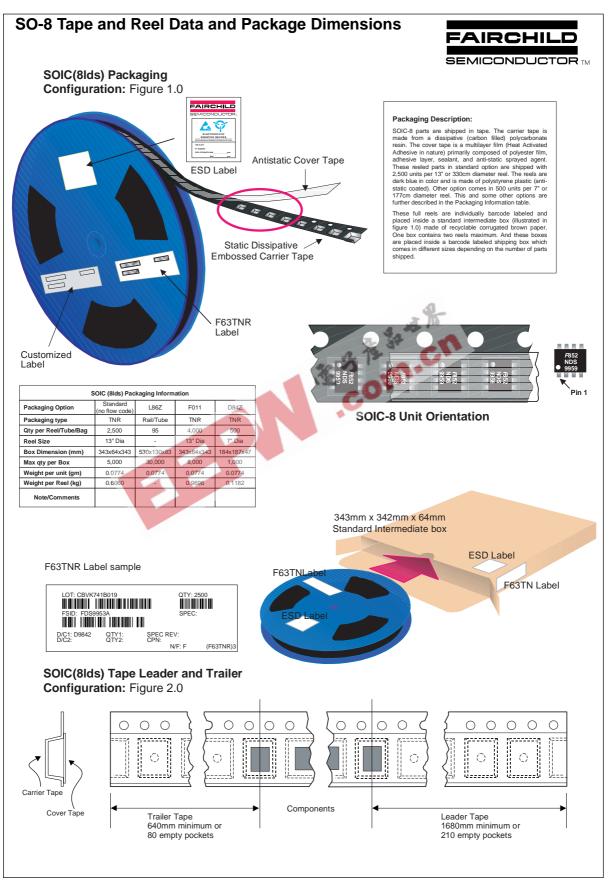
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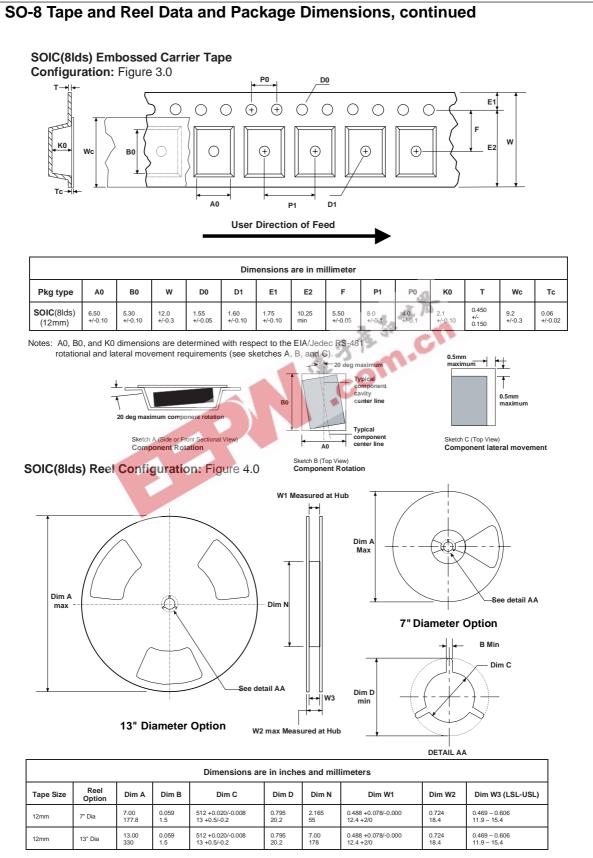


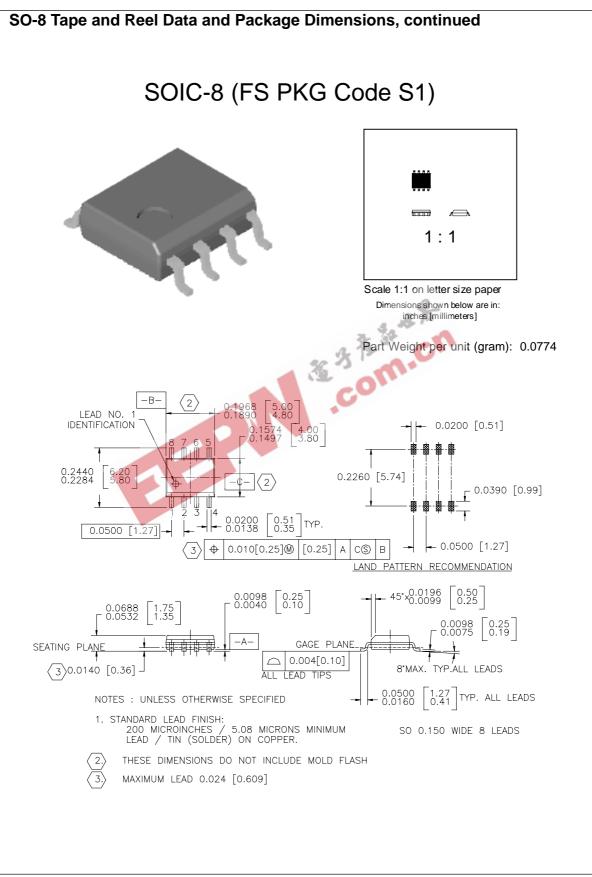
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July 1999, Rev. B





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|--------------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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